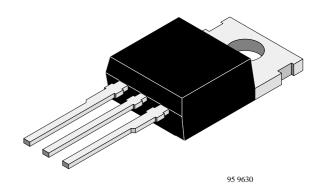


Vishay Lite-On Power Semiconductor

20A Schottky Barrier Rectifier

Features

- Schottky barrier chip
- Guard ring die constuction for transient protection
- Low power loss, high efficiency
- High current capability and low forward voltage drop
- High surge capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection application
- Plastic material UL Recognition flammability classification 94V–0



Absolute Maximum Ratings

 $T_i = 25^{\circ}C$

Parameter	Test Conditions	Туре	Symbol	Value	Unit
Repetitive peak reverse voltage		SBL2030CT	V _{RRM}	30	V
=Working peak reverse voltage		SBL2035CT	$=V_{RWM}$	35	V
=DC Blocking voltage		SBL2040CT	=V _R	40	V
		SBL2045CT		45	V
		SBL2050CT		50	V
		SBL2060CT		60	V
Peak forward surge current			I _{FSM}	250	Α
Average forward current	T _C =95°C		I_{FAV}	20	Α
Junction and storage temperature range			$T_i=T_{sta}$	<i>−</i> 65+150	°C

Electrical Characteristics

 $T_i = 25^{\circ}C$

-) == =							
Parameter	Test	Type	Symbol	Min	Тур	Max	Unit
	Conditions						
Forward voltage	I _F =10A, T _C =25°C	SBL2030CT-SBL2045CT	V_{F}			0.55	V
		SBL2050CT-SBL2060CT	V_{F}			0.75	V
Reverse current	T _C =25°C		I _R			1.0	mA
	T _C =100°C		I_R			50	mΑ
Diode capacitance	V _R =4V, f=1MHz		C_{D}		650		рF
Thermal resistance	T _L =const.		R_{thJC}		2.8		K/W
junction to case							

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Vishay Lite-On Power Semiconductor



Characteristics $(T_i = 25^{\circ}C \text{ unless otherwise specified})$

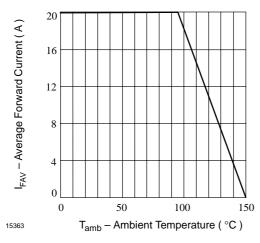


Figure 1. Max. Average Forward Current vs.
Ambient Temperature

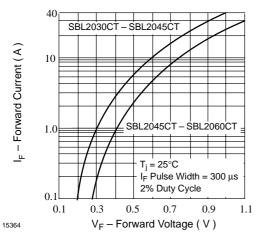


Figure 2. Typ. Forward Current vs. Forward Voltage

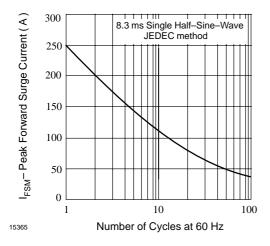


Figure 3. Max. Peak Forward Surge Current vs. Number of Cycles

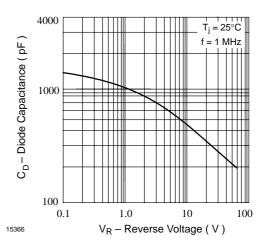


Figure 4. Typ. Diode Capacitance vs. Reverse Voltage

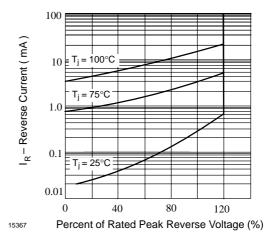


Figure 5. Typ. Reverse Current vs. Percent of Rated Peak Reverse Voltage

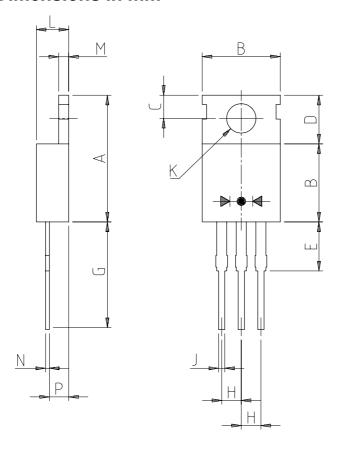
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Vishay Lite-On Power Semiconductor

Dimensions in mm



	TO-220AB				
Dim	Min	Max			
А	14.22	15.88			
В	9.65	10.67			
	2.54	3.43			
D	5.84	6.86			
Е	ı	6.25			
G	12.70	14.73			
Н	2.29	2.79			
J	0.51	1.14			
K	Ø3.53	Ø4.09			
L	3.56	4.83			
М	1.14	1.40			
N	0.30	0.64			
Р	2.03	2.92			
All Dimensions in mm					



technical drawing according to DIN specifications

14468

Case: molded plastic Polarity: as marked on body Approx. weight: 2.24 grams Mounting position: any Marking: type number

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SBL2030CT-SBL2060CT

Vishay Lite-On Power Semiconductor



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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